

I_D Max.

7A



20V, 14.5mΩ, 7A, N-Channel MOSFET

V_{DS} Typ.

20V

R_{DS(on)} Typ.

14.5mΩ @ 4.5V

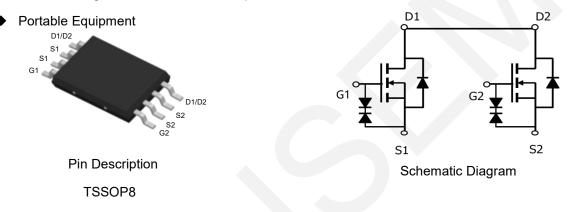
17mΩ @ 2.5V

1.Features

- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

2.Applications

- Battery Protection
- Battery Powered Systems
- Power Management in Notebook Computer



3.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	V _{DSS}	20	V
Gate to Source Voltage	V _{GSS}	±12	V
Drain Current-Continuous	ID	7	А
Drain Current (Pulse)	I _{DM}	25	А
Maximum Power Dissipation	PD	1.5	W
Operating Junction and Storage Temperature Range	Tj, Tstg	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

4.Thermal Resistance Ratings (Note 2)

Parameter	Symbol	Value	Unit
Maximum Junction-to-Ambien	R _{0JA}	64	°C/W

Note 2: When mounted on 1 inch square copper board $t \le 10$ sec The value in any given application depends on the user's specific board design.



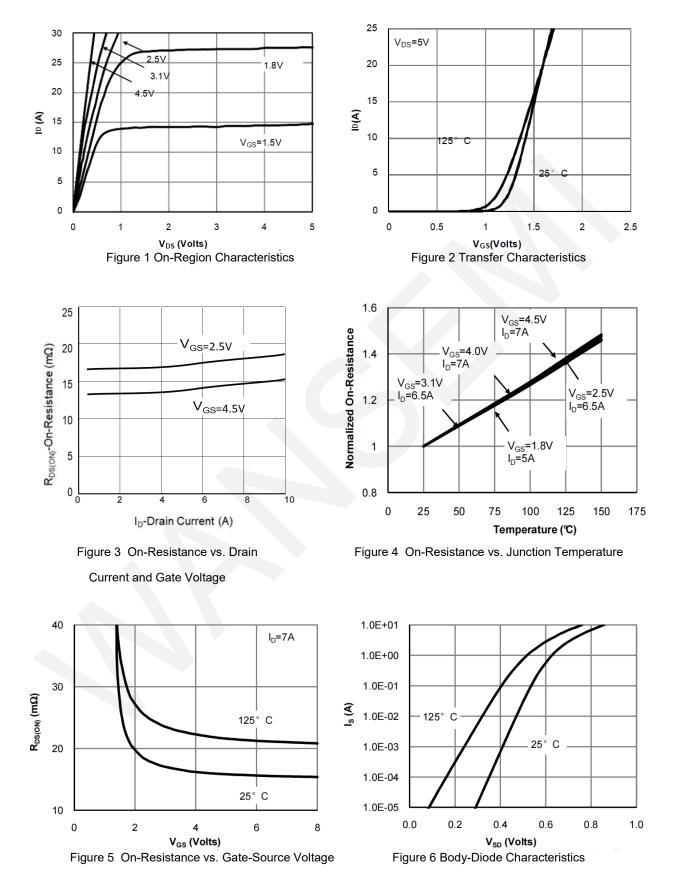
5.Electrical Characteristics at Ta=25°C (Note 3)						
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V _{(BR)DSS}	I_{D} = 250µA, V_{GS} = 0V	20			V
Zero-Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20V, V _{GS} = 0V			1	μA
Gate-Body Leakage Current	I _{GSS}	$V_{GS} = \pm 12V, V_{DS} = 0V$			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _{DS} =250µA	0.5		1.0	V
Drain to Source On-State	_	I _D = 7A, V _{GS} = 4.5V		14.5	17	mΩ
Resistance	$R_{DS(on)}$ $I_D = 6.5A, V_{GS} = 2.5V$	I _D = 6.5A, V _{GS} = 2.5V		17	25	mΩ
Input Capacitance	Ciss	V _{GS} =0V, V _{DS} =10V, Frequency=1.0MHz		1300		pF
Output Capacitance	C _{oss}			160		рF
Reverse Transfer Capacitance	Crss			90		pF
Turn-ON Delay Time	t _{d(on)}	V _{DD} = 10V, V _{GS} = 4.5V, R _{GEN} = 3Ω,R _L = 1.54Ω		280		ns
Turn-ON Rise Time	tr			330		ns
Turn-OFF Delay Time	t _{d(off)}			3.76		ns
Turn-ON Fall Time	t _f			2.24		ns
Total Gate Charge	Qg	$V_{DS} = 10V,$ $V_{GS} = 4.5V,$ $I_{D} = 7A$		10		nC
Gate-Source Charge	Q _{gs}			4		nC
Gate-Drain Charge	Q _{gd}			2.8		nC
Diode Forward Voltage	V _{SD}	I _S = 1A, V _{GS} = 0V		0.65	1.4	V

5.Electrical Characteristics at Ta=25°C (Note 3)

Note 3 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



6.Typical electrical and thermal characteristics





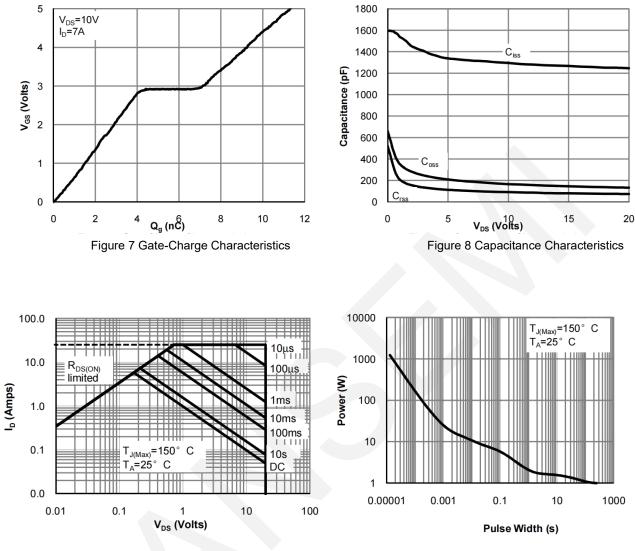
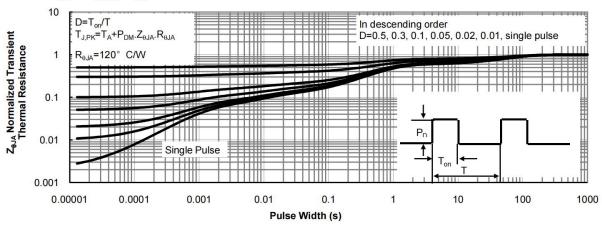


Figure 9 Safe Operating Area

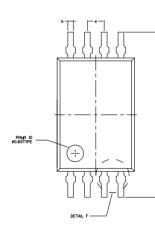
Figure 10 Single Pulse Power Rating Junction-to- Ambient

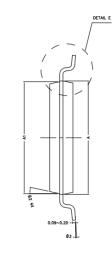


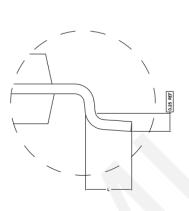




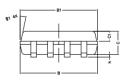
7.Package Dimensions







DETAIL E





DETAIL F

1				
COMMON DIMENSIONS (UNITS OF MEASURE IS mm)				
	MIN	NORMAL	MAX	
A	4.300	4.400	4.500	
A1	4.240	4.340	4.440	
В	2.900	3.000	3.100	
B1	2.840	2.940	3.040	
AC	0.850	0.900	0.950	
C1	0.337	0.387	0.437	
D	6.250	6.400	6.550	
L	0.450	0.600	0.750	
b	0.170	0.220	0.300	
"Аh	0.050	0.100	0.150	
е	0.650TYPE			
θ1	12° TYPE			
θ2	12° TYPE			
θკ	0°~ 7°			



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